

# 20 V NPN/PNP low V<sub>CEsat</sub> (BISS) transistor Rev. 2 — 13 October 2010

Product data sheet

#### **Product profile** 1.

#### **1.1 General description**

NPN/PNP low V<sub>CEsat</sub> Breakthrough In Small Signal (BISS) transistor in a SOT96-1 (SO8) medium power Surface-Mounted Device (SMD) plastic package.

#### Table 1. **Product overview**

Type number			NPN/NPN	PNP/PNP	
	Nexperia	Name	complement	complement	
PBSS4021SPN	SOT96-1	SO8	PBSS4021SN	PBSS4021SP	

#### 1.2 Features and benefits

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (h<sub>FF</sub>) at high I<sub>C</sub>
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

#### 1.3 Applications

- Loadswitch
- Battery-driven devices
- Power management

- Charging circuits
- Power switches (e.g. motors, fans)

#### 1.4 Quick reference data

#### Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1; NPN	low V <sub>CEsat</sub> transistor					
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	20	V
I <sub>C</sub>	collector current		-	-	7.5	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-	15	А
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C} = 5 \text{ A}; I_{B} = 0.5 \text{ A}$	<u>[1]</u> _	25	35	mΩ

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Table 2.	Quick reference data continued						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
TR2; PNP	Plow V <sub>CEsat</sub> transistor						
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	-20	V	
I <sub>C</sub>	collector current		-	-	-6.3	А	
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-	-15	А	
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C} = -5 \text{ A}; I_{B} = -0.5 \text{ A}$	<u>[1]</u> _	36	54	mΩ	

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .

### 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol		
1	emitter TR1				
2	base TR1		8765		
3	emitter TR2				
4	base TR2				
5	collector TR2				
6	collector TR2		006aaa985		
7	collector TR1				
8	collector TR1				

### 3. Ordering information

Table 4. Orde	ring inform	nation	
Type number	Package		
	Name	Description	Version
PBSS4021SPN	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1

### 4. Marking

Table 5.	Marking codes	
Type num	ber	Marking code
PBSS402	1SPN	4021SPN

PBSS4021SPN

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### 5. Limiting values

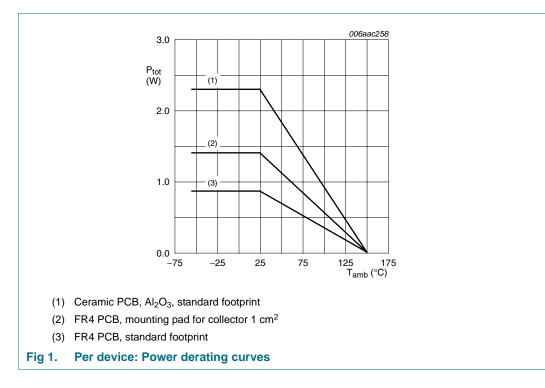
Symbol	Parameter	Conditions	Min	Max	Unit
TR1 (NPN	۱)				
I <sub>C</sub>	collector current		-	7.5	А
TR2 (PNF	?)				
l <sub>C</sub>	collector current		-	-6.3	А
Per trans	istor; for the PNP transist	or with negative polarity			
V <sub>CBO</sub>	collector-base voltage	open emitter	-	20	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	20	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	15	А
I <sub>B</sub>	base current		-	1	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	0.73	W
			[2]	1	W
			[3]	1.7	W
Per devic	e				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	0.86	W
			[2] _	1.4	W
			[3]	2.3	W
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.

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### 6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	sistor					
R <sub>th(j-a)</sub>	thermal resistance from	in free air	<u>[1]</u> _	-	170	K/W
	junction to ambient		[2] _	-	125	K/W
			[3]	-	75	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	40	K/W
Per devi	ce					
R <sub>th(j-a)</sub>	thermal resistance from	in free air	<u>[1]</u> _	-	145	K/W
	junction to ambient		[2]	-	90	K/W
			[3]	-	55	K/W

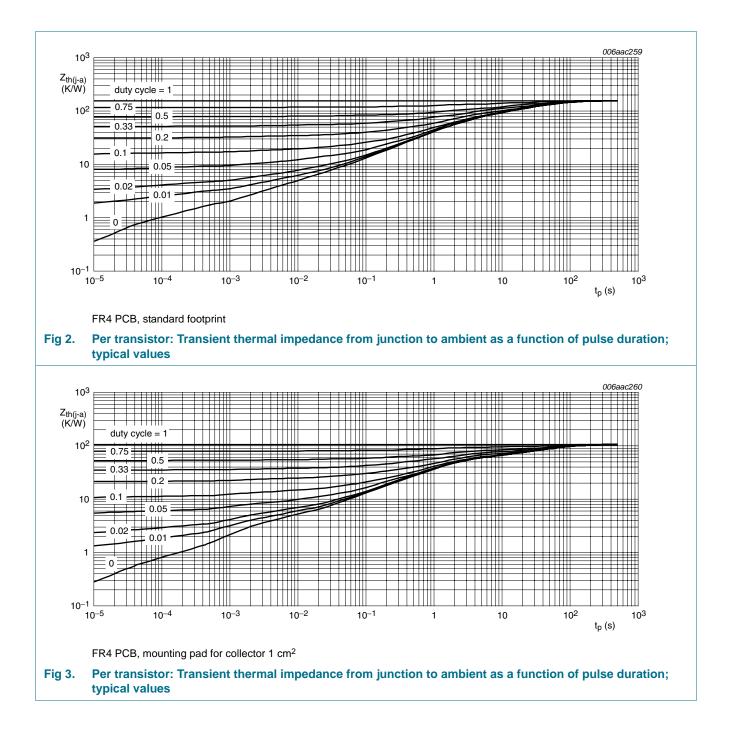
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

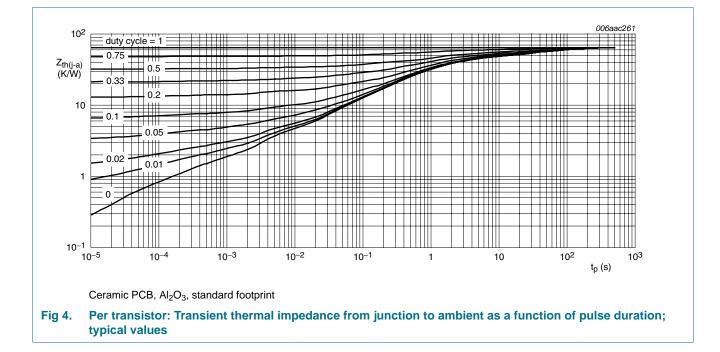
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### 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1; NP	N low V <sub>CEsat</sub> transisto	r					
I <sub>CBO</sub> collector-base		V <sub>CB</sub> = 20 V; I <sub>E</sub> = 0 A		-	-	100	nA
	cut-off current	$V_{CB} = 20 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	50	μA
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = 16 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 V$	[1]				
		I <sub>C</sub> = 500 mA		300	550	-	
		I <sub>C</sub> = 1 A		300	550	-	
		I <sub>C</sub> = 2 A		300	500	-	
		$I_{\rm C} = 4$ A		250	450	-	
		I <sub>C</sub> = 8 A		100	200	-	
V <sub>CEsat</sub>	collector-emitter		[1]				
	saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA		-	30	45	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 10 mA		-	40	60	mV
		$I_{C} = 2 \text{ A}; I_{B} = 40 \text{ mA}$		-	60	90	mV
		$I_{C} = 4 \text{ A}; I_{B} = 200 \text{ mA}$		-	100	150	mV
		$I_{C} = 4 \text{ A}; I_{B} = 40 \text{ mA}$		-	120	180	mV
		$I_{C} = 7.5 \text{ A}; I_{B} = 375 \text{ mA}$		-	185	275	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = 5 A; I <sub>B</sub> = 500 mA	[1]	-	25	35	mΩ
V <sub>BEsat</sub>	base-emitter		[1]				
	saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA		-	0.87	1	V
		I <sub>C</sub> = 4 A; I <sub>B</sub> = 400 mA		-	1.04	1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 2 \text{ A}$	<u>[1]</u>	-	0.76	0.85	V
t <sub>d</sub>	delay time	$V_{CC}$ = 12.5 V; I <sub>C</sub> = 1 A;		-	40	-	ns
t <sub>r</sub>	rise time	$I_{Bon} = 0.05 \text{ A}; I_{Boff} = -0.05 \text{ A}$		-	40	-	ns
t <sub>on</sub>	turn-on time			-	80	-	ns
t <sub>s</sub>	storage time			-	650	-	ns
t <sub>f</sub>	fall time			-	75	-	ns
t <sub>off</sub>	turn-off time			-	725	-	ns
f <sub>T</sub>	transition frequency	$V_{CE}$ = 10 V; I <sub>C</sub> = 100 mA; f = 100 MHz		-	115	-	MHz
C <sub>c</sub>	collector capacitance	$\label{eq:VCB} \begin{split} V_{CB} &= 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ \text{f} &= 1 \text{ MHz} \end{split}$		-	85	-	pF

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Symbol	Parameter	Conditions	N	/lin	Тур	Max	Unit
TR2; PN	P low V <sub>CEsat</sub> transisto	r					
I <sub>CBO</sub>	collector-base	$V_{CB} = -20 \text{ V}; I_E = 0 \text{ A}$	-		-	-100	nA
	cut-off current	$\label{eq:VCB} \begin{array}{l} V_{CB} = -20 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \\ T_{j} = 150 \ ^{\circ}\text{C} \end{array}$	-		-	-50	μA
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = -16 \text{ V};  V_{BE} = 0 \text{ V}$	-		-	-100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-		-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -2 V$	<u>[1]</u>				
		I <sub>C</sub> = -500 mA	2	50	400	-	
		$I_{\rm C} = -1$ A	2	50	400	-	
		$I_{\rm C} = -2  {\rm A}$	2	200	350	-	
		$I_{\rm C} = -4$ A	1	50	300	-	
		I <sub>C</sub> = -7 A	8	0	200	-	
V <sub>CEsat</sub>	collector-emitter		[1]				
	saturation voltage	$I_{\rm C} = -1$ A; $I_{\rm B} = -50$ mA	-		-45	-68	mV
		$I_{\rm C} = -1$ A; $I_{\rm B} = -10$ mA	-		-70	-115	mV
		$I_{\rm C} = -2$ A; $I_{\rm B} = -40$ mA	-		-100	-150	mV
		$I_{\rm C} = -4$ A; $I_{\rm B} = -200$ mA	-		-150	-225	mV
		$I_{\rm C} = -4$ A; $I_{\rm B} = -40$ mA	-		-250	-375	mV
		$I_{\rm C}$ = -6.5 A; $I_{\rm B}$ = -325 mA	-		-235	-350	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C} = -5 \text{ A}; I_{B} = -500 \text{ mA}$	<u>[1]</u> _		36	54	mΩ
V <sub>BEsat</sub>	base-emitter		[1]				
	saturation voltage	$I_{\rm C} = -1$ A; $I_{\rm B} = -100$ mA	-		-0.85	-1	V
		$I_{C} = -4 \text{ A}; I_{B} = -400 \text{ mA}$	-		-1	-1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}$	<u>[1]</u> _		-0.76	-0.85	V
t <sub>d</sub>	delay time	$V_{CC} = -12.5 \text{ V}; I_C = -1 \text{ A};$	-		40	-	ns
t <sub>r</sub>	rise time	$I_{Bon} = -0.05 \text{ A}; I_{Boff} = 0.05 \text{ A}$	-		55	-	ns
t <sub>on</sub>	turn-on time		-		95	-	ns
t <sub>s</sub>	storage time		-		340	-	ns
t <sub>f</sub>	fall time		-		85	-	ns
t <sub>off</sub>	turn-off time		-		425	-	ns
f <sub>T</sub>	transition frequency	$V_{CE} = -10 \text{ V}; I_{C} = -100 \text{ mA};$ f = 100 MHz	-		105	-	MH
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-		95	-	pF

### Table 8. Characteristics ...continued T 25 °C unloss otherwise specified

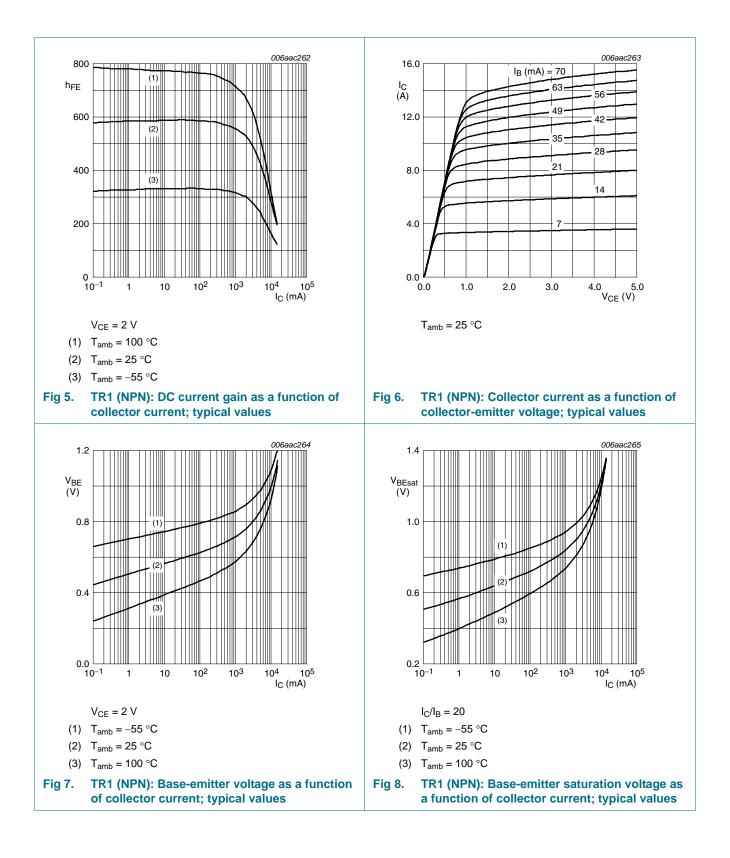
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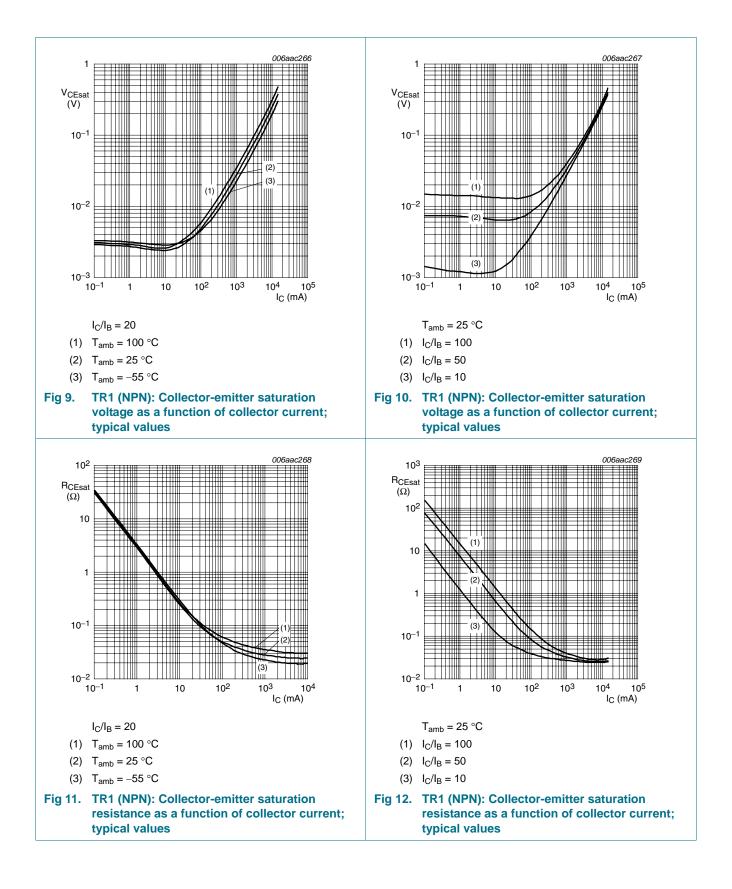
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# PBSS4021SPN

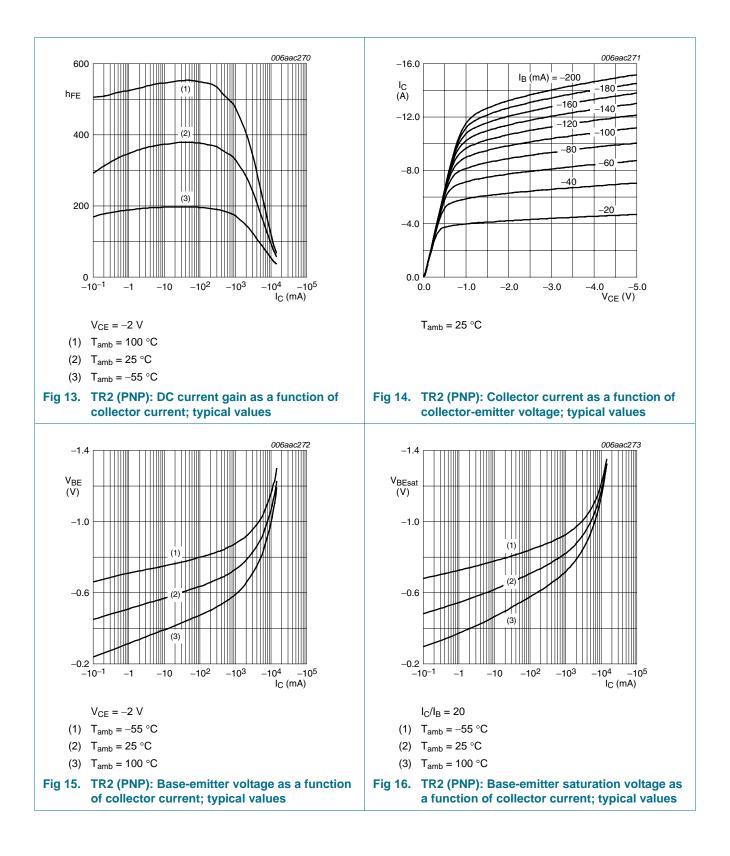
#### 20 V NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



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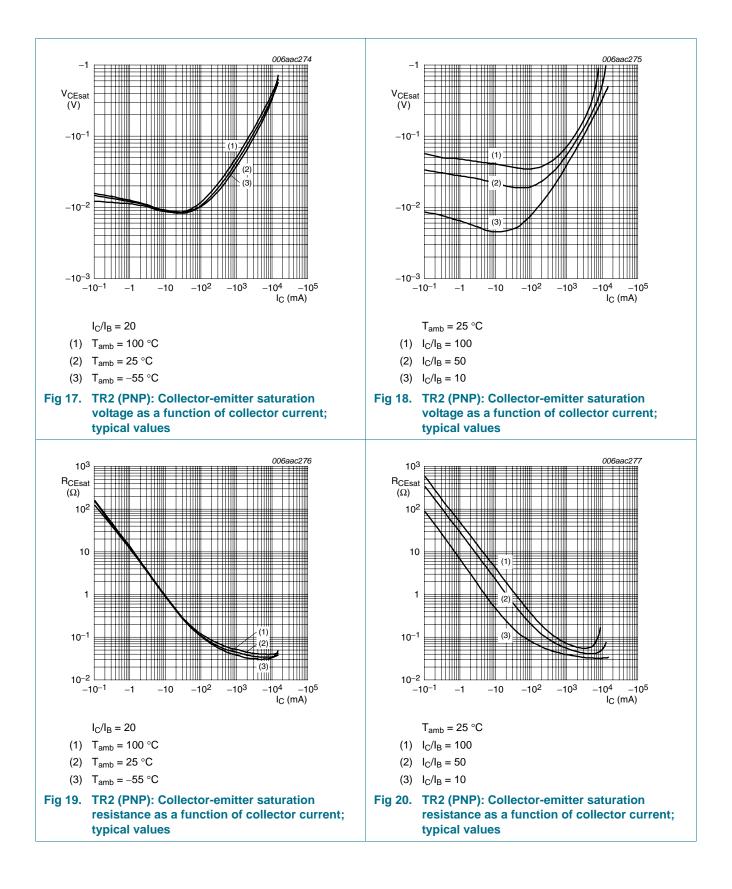
#### 20 V NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



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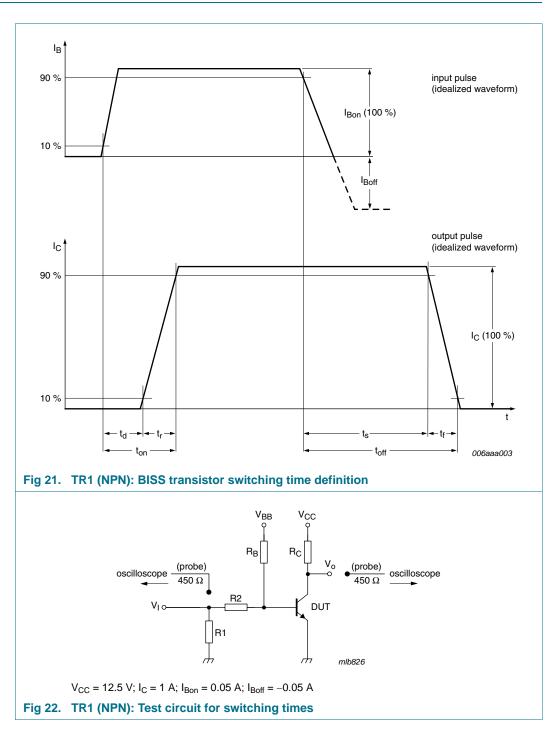
#### 20 V NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



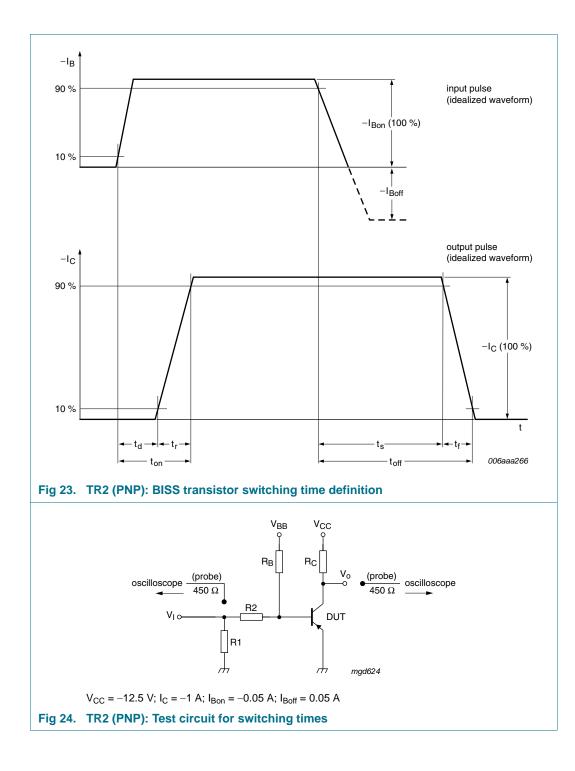
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### 8. Test information



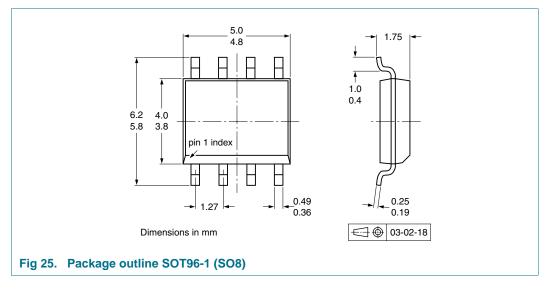
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### 9. Package outline



### **10. Packing information**

#### Table 9. Packing methods

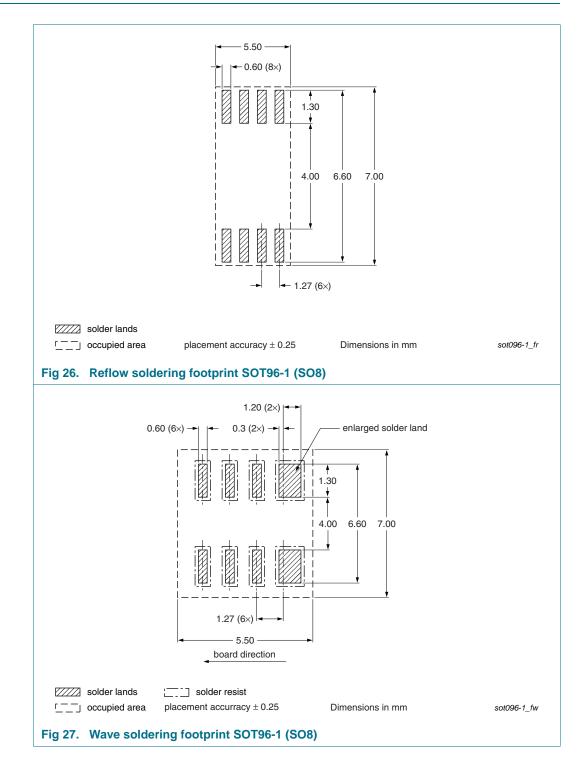
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			1000	2500
PBSS4021SPN	SOT96-1	8 mm pitch, 12 mm tape and reel	-115	-118

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

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### **11. Soldering**



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### **12. Revision history**

Table 10. Revision hi	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4021SPN v.2	20101013	Product data sheet	-	PBSS4021SPN v.1
Modifications:	• Figure 1 "Pe	er device: Power derating cu	urves": updated.	
PBSS4021SPN v.1	20100714	Product data sheet	-	-

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### **13. Legal information**

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nexperia.com">http://www.nexperia.com</a>.

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**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

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